

### **Description**

The **NA-FRA381-A13A** is a small package, single-ended output bottom port analog MEMS microphone, consists of a MEMS sensor and a low noise level ASIC.

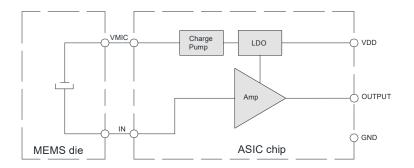
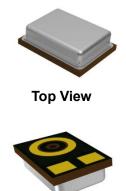


Fig. 1 Microphone block diagram



**Bottom View** 

### **Key Features**

- ♦ Single Ended Output
- ♦ Narrow Sensitivity +/-1dB
- ♦ SNR of 62dBA
- ♦ RF Shielded
- Compatible with Standard SMD Reflow Technology
- ♦ RoHSCompliance&Halogen Free

### **Typical Applications**

- Mobilephones
- ♦ Wireless Headsets
- ♦ Smart Speakers
- Wearable Electronics
- ♦ Portable Electronics
- Smart Home Electronics

## **Maximum Ratings**

Stresses at the maximum ratings shown in Table 1 may cause permanent damage to the device. These are stress ratings only at which the device may not function when an operation at these or any other condition beyond those specified under "Electro-Acoustic Specifications".

**Table 1 Maximum Ratings** 

Parameter	Maximum Ratings	Unit
Supply voltage	4.2	V
Operation temperature range	-40~85	$^{\circ}$ C
Storage temperature range	-40~100	$\mathbb{C}$



# **Electro-Acoustic Specifications**

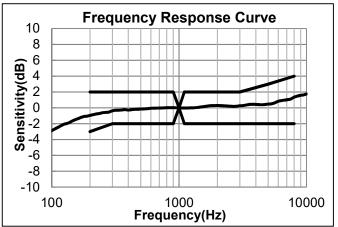
#### **Table 2 Electrical Specifications**

Test condition:+25±2°C,60%~70% RH,86~106Kpa, Vdd=2V, no load,unless otherwise specified.

No.	Parameter	Symbol	Condition	Min.	Nom.	Max.	Unit
1	Sensitivity	S	f=1kHz, Pin=1Pa, 0dB=1V/Pa	-39	-38	-37	dB
2	Operating Voltage	$V_{DD}$		1.6	2	3.6	V
3	Directivity			Omni-d	irectional		
4	Polarity		Sound pressure increase	Output	voltage ir	ncrease	
5	Sensitivity vs. Voltage	ΔS	Vs= 3.6V to 1.6V	<0.5			dB
6	Output Impedance	Z <sub>OUT</sub>	f=1kHz			400	Ω
7	Current Consumption	1	1.6 V to 3.6V		120	200	μA
8	S/N Ratio	S/N	20-20KHz Bandwidth, A-Weighted	60	62		dBA
	Total Harmonic	THD	94dB SPL @1KHz		0.05	0.5	- %
9 Dis	Distortion		125dBSPL @1KHz		1		70
10	Acoustic Overload Point	AOP	THD 10%@1KHz		127		dBSPL
11	Power Supply Rejection	PSR	100mVpp Square wave @217Hz, A-weighted		-100	-90	dB
12	Power Supply Rejection Ratio	PSRR	200mVpp Sinewave @1KHz	60	68		dB
13	DC output	VDC			0.85		V
14	Output load	C <sub>load</sub>				100	pF
14	Output load	R <sub>load</sub>		8			ΚΩ

Note: Frequency response, sensitivity and current consumption are tested by 100% on product line.

#### **Performance Curves**



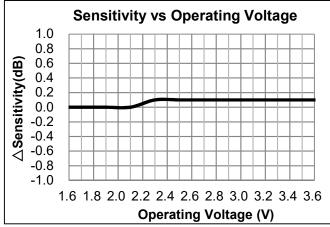
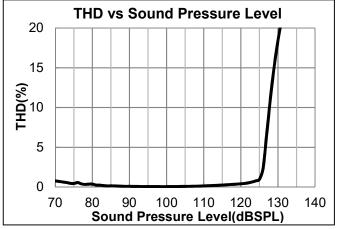
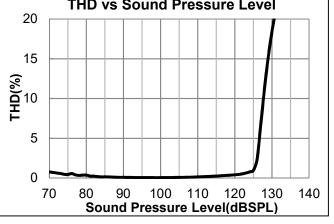


Fig.2 Frequency response curve normalized to 1 kHz

Fig. 3 Sensitivity vs Operating Voltage

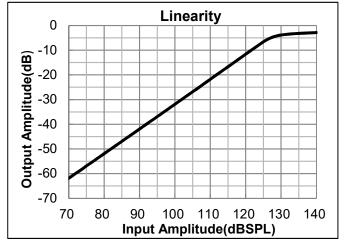




**Current Consumption vs Operating** Voltage Current Consumption(uA) 180 160 140 120 80 80 1.6 1.8 2 2.2 2.4 2.6 2.8 3 3.2 3.4 3.6 **Operating** 

Fig. 4 Typical THD vs Sound Pressure Level

Fig. 5 Typical Current vs Operating Voltage



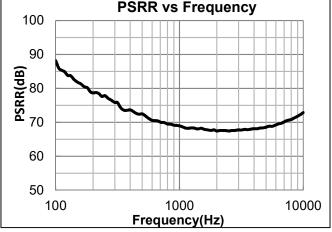


Fig. 6 Linearity

Fig. 7 Typical PSRR curve



# **Measurement System Setup**

Test signal: Sinusoid, Sweep,

Step: 1/12 octave

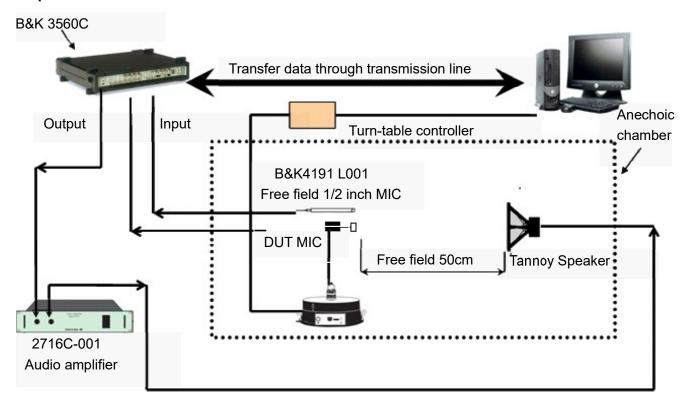


Fig. 8 Measurement System Setup



### **Typical Application Circuit**

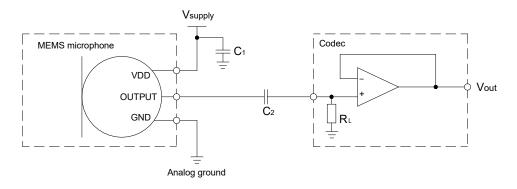


Fig. 9 Typical Application Circuit

### Power supply decoupling:

A 0.1uF ceramic type decoupling capacitor C₁is strongly recommended for every microphone and it should be placed as close to the VDD pad to reduce the noise on power supply;

The trace connected to each pad of capacitor should be as short as possible, and should stay on one layer of PCB without via. For the best performance, recommend to place the capacitor equidistance from power and ground pins of microphone, or slightly closer to the power pin if space not allowed. System ground should connect to far side of the capacitor, as shown in fig.10.

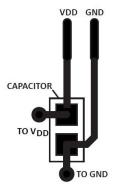


Fig. 10 Recommended Power Supply Decoupling Capacitor Layout

#### Low frequency roll-off:

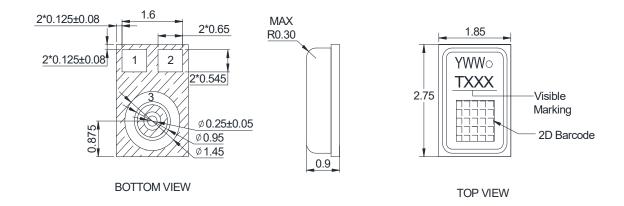
DC-blocking capacitor  $C_2$  is required on the output signal line. The 3-dB cut-off frequency can be calculated using follow equation which is related to DC-blocking capacitor  $C_2$  and input resistance of the input amplifier.

3dB cut-off frequency=1/2πR<sub>L</sub>C<sub>2</sub>

In order to get a cut-off frequency below 20 Hz, minimum 1uF value of  $C_2$  and minimum 20K $\Omega$  value of input resistance of the input amplifier is recommended.



### **Mechanical Specifications**



Unit: mm Unmarked Tolerance: ± 0.1 (mm)

Fig. 11 Dimension

Item	Dimension	Tolerance
Length	2.75	±0.1
Width	1.85	±0.1
Height	0.90	±0.1
Acoustic Port	0.25	±0.05

PIN	Definition	Description
1	VDD	Power Supply
2	Output	Signal Output
3	GND	Ground

#### Note:

- All Ground Pin must be connected to the ground in end application
- Identification Marking

Y: Year WW: Week o: Polarity sign

T: GETTOP XXX: Serial Number

2D Barcode



### **Reliability Specifications**

After conducting any of the following tests, the sensitivity change of DUT shall be less than±3dB from its initial value unless otherwise noted, and shall keep its initial operation and appearance.

**Table 3 Reliability Specifications** 

No.	Item	Test condition
1	Preconditioning	24 hour bake at 125°C, followed by 168 hours at 85°C, 85%RH, followed by 3 passes solder reflow only for the following three tests:  High Humidity &High Heat operating Test High Humidity &High Heat operating Test Thermal Shocking Test
2	Hi-Temperature Storage Test	105±3℃,1000h,recover for two hours
3	Hi-Temperature operating Test	105±3℃, under upper limit bias,1000h,recover for two hours
4	Low-Temperature storage Test	-40±3℃,1000h, recover for two hours
5	Low-Temperature operating Test	-40±3℃, under upper limit bias,1000h,recover for two hours
6	High Humidity &High Heat operating Test	85±3℃, 85%RH, under upper limit bias, 1000h,recover for two hours, there should be no corrosion and deformation inside of microphone after testing
7	High Humidity &High Heat operating Test	65±3℃, 95%RH, under upper limit bias, 168h,recover for two hours ,there should be no corrosion and deformation inside of microphone after testing
8	Thermal Shocking Test	Double-Case Method, -40°C for 15mins→125°C for 15 mins, 100 cycles, recover for two hours
9	Vibration Test	Each 12mins for X, Y and Z axes, Frequency: 20~2000Hz, Peak Acceleration 20g, recover for two hours
10	Drop Test	Height:1.5m Fixture Weight:150g (Sound Hole Diameter in the fixture is >=0.8mm) Reference Surface: slippery marble floor Duration:4 corners*4 times, 6 faces*4 times The sensitivity change should be less than 1dB after testing
11	Tumbling Test	Height:1.0m Fixture Weight:150g (Sound Hole Diameter in the fixture is >=0.8mm) Duration: 300 times Recommended Time: 10-11times/Min The sensitivity change should be less than 1dB after testing



		a. HMB Discharge Position: Charge Voltage:	I/O pins ±3000V	
12	ESD Test 1	Discharge Network: b. CDM Discharge Position: Charge Voltage:	100pF & 1500Ω I/O pins ±250V	
13	ESD Test 2	The tests are performed acc. to IEC61000-4-2 level 3:  a. Contact Discharge Discharge Position: Output of Microphone Charge Voltage:±6000VDC Discharge Network:150pF & 330Ω b. Air Discharge Discharge Position: Sound Hole Charge Voltage:±8000VDC Discharge Network:150pF & 330Ω		
14	Structure Shock Test	10000g, Duration: 0.1ms, each 3 shocks for X/Y/Z 3 axes, The sensitivity change should be less than 1dB after testing		
15	Reflow	3 reflow cycles with peak temperature of +260°C according to reflow profile		



### **Packaging Details**

- \* Use ESD reel and tape for microphone packaging.
- \* Anti-static measures should be applied during packaging operation.

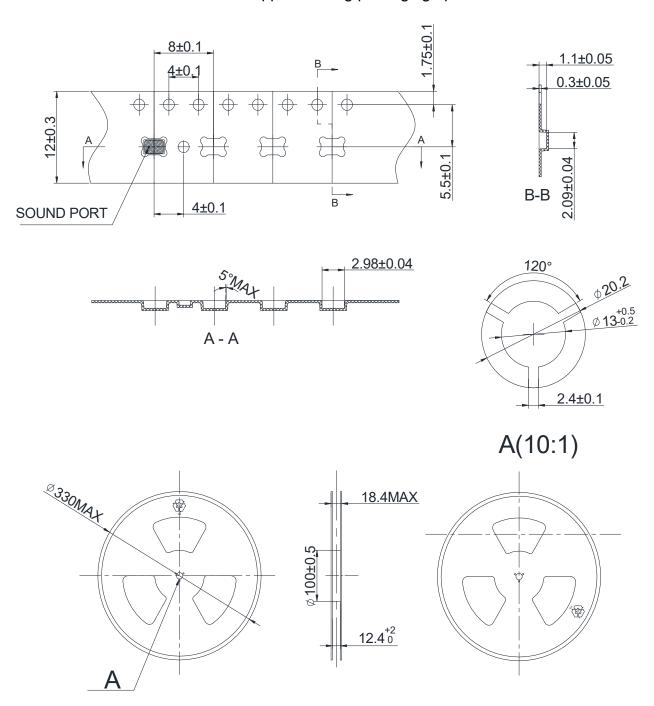
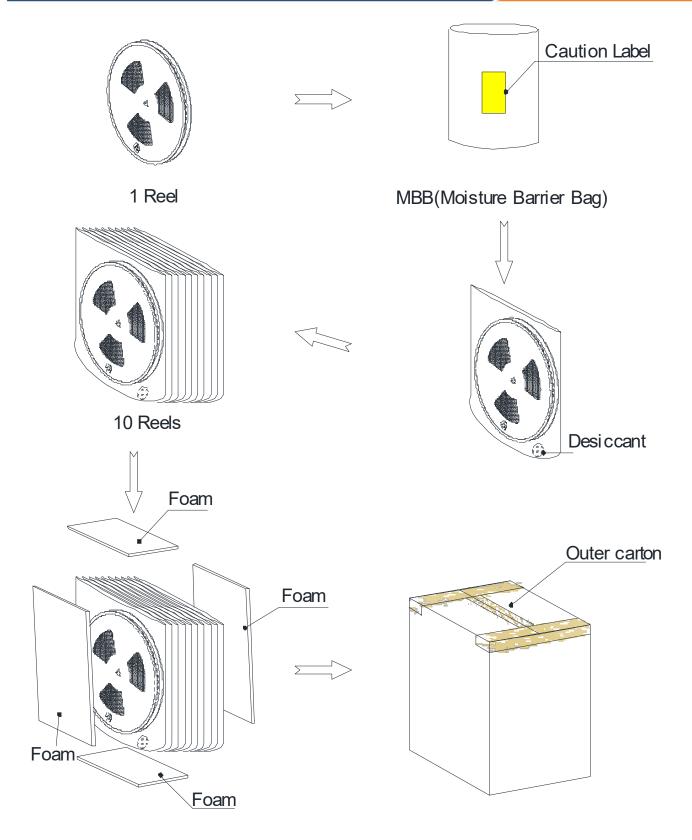


Fig. 12 Packaging



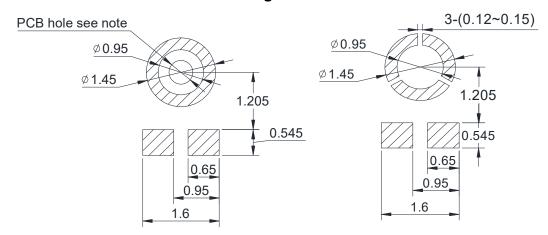


Tape and Reel	φ330mm	5,500PCS×1=5,500PCS
Shipping Box	215mm*370mm*370mm	5,500PCS×10=55,000PCS



### **Application Design Suggestions**

### **Recommended PCB and Stencil Design Pattern**



**Example Land Pattern** 

**Example Solder Stencil Pattern** 

#### Notes:

- Dimensions are in millimeters unless otherwise specified.
- Tolerance is  $\pm 0.1$ mm unless otherwise specified.
- The recommended non-plated hole diameter of PCB is 0.5-0.7mm.

### **Temperature Profile during Reflow Process**

**Table 4 Temperature Profile during Reflow Process** 

Parameter		Reference	Specification
Average Ramp Rate		T <sub>L</sub> to T <sub>P</sub>	3°C/sec max
	Minimum Temperature	T <sub>SMIN</sub>	150°C
Preheat	Maximum Temperature	T <sub>SMAX</sub>	200°C
	Time T <sub>SMIN</sub> to T <sub>SMAX</sub>	ts	60 sec to 180 sec
Ramp-Up Rate		T <sub>SMAX</sub> to T <sub>L</sub>	1.25°C/sec
Time Maintained Above Liquidous		t <sub>L</sub>	60 sec to 150 sec
Liquidous Temperature		TL	217°C
Peak Temperature		T <sub>P</sub>	260°C
Time Within +5°C of Actual Peak Temperature		t <sub>P</sub>	20 sec to 40 sec
Ramp-Down Rate		T <sub>P</sub> to T <sub>SMAX</sub>	6°C/sec max
Time +25°C (t25°C) to Peak Temperature			8 min max

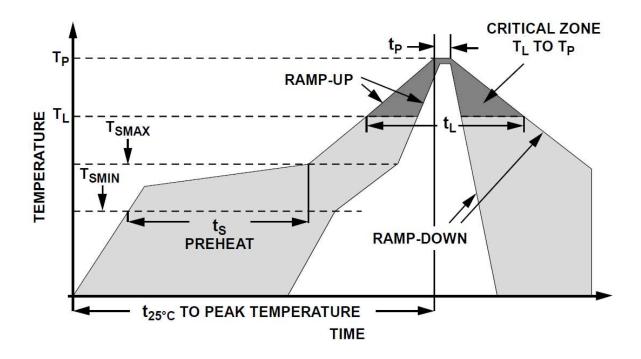


Fig. 13 Reflow Profile

#### Additional Notes:

- Mic should cool to room temp before next flow cycle if more reflow is needed.
- No more than 3 times reflow is recommended.
- Do not board wash by liquid or ultrasonic after the reflow process.
- Do not pull a vacuum over port hole of the microphone.
- Do not insert any object in port hole of device at any time.
- Suggest SMT the microphone at last time if double side PCBA used.
- Do not seal sound port during reflow .
- If there is any leakage risk, the peak temperature should be set to less than 240°C or more than 255°C.



#### Recommended nozzle for reflow MIC

External diameter is Φ1.3mm Inside diameter is Φ1.0mm

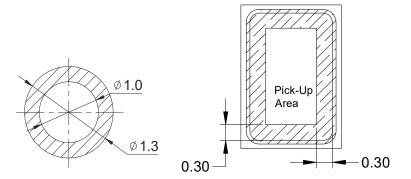


Fig. 14Recommended nozzle for reflow MIC and Pick-up Area

### **Special Cautions**

### **Air Rifle Cleaning Restriction**

Do not bring air rifle to the port hole directly.

Recommended Condition:

Air pressure < 0.3MPa;

Distance>5cm;

Time<5 sec.

#### **Package**

Do not vacuum seal unused material for storage. Vacuum Sealing can cause mic damage.

#### Storage

The component needs to meet the requirement of MSL(Moisture Sensitivity Level) class 1. Please keep MICs in warehouse with humidity less than 75% and without sudden temperature change, acid air, and any other harmful air or strong magnetic field.

Please protect products against moist, shock, sunburn and pressure.

Please take proper measures against ESD in the process of assembly and transportation.

Please use the shipping package for long-term storage.

#### **Discard**

For microphones to be wasted, customer shall follow the regulation of Waste Electrical and Electronic Equipment (WEEE) Directive (2002/96/EC).

Notes: More application suggestions can be found in the latest "MEMS Microphone Application Notes".



# **Specification Revisions**

Date	Version	Description
07-16-2024	V1.0	Initial release